ABSTRACT

This EVM user's guide describes the characteristics, operation, and use of the INA233EVM evaluation board. It discusses how to set up and configure the software and hardware, and reviews various aspects of the program operation. Throughout this document, the terms evaluation board, evaluation module, and EVM are synonymous with the INA233EVM. This EVM user's guide also includes information regarding operating procedures and input/output connections, an electrical schematic, printed circuit board (PCB) layout drawings, and a parts list for the EVM.

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1 Overview

The INA233 is a current shunt and power monitor with an I2C/SMBus/PMBus-compatible interface. The device monitors and reports values for current, power, and voltage. The integrated power accumulator can be used for energy or average power calculations. Programmable calibration value, conversion times, and averaging, combined with an internal multiplier, enable direct readouts of current in amperes and power in watts. The INA233EVM is a platform for evaluating the performance of the INA233 under various signal, shunt, and supply conditions.

This document gives a general overview of the INA233EVM, and provides a general description of the features and functions to be considered while using this evaluation module.

1.1 INA233EVM Kit Contents

Table 1-1 summarizes the contents of the INA233EVM kit. Figure 1-1 shows all of the included hardware. Contact the Texas Instruments Product Information Center if any component is missing. TI also highly recommends checking the INA233 product folder on the TI web site at www.ti.com to update to the latest versions of the related software.

<table>
<thead>
<tr>
<th>Item</th>
<th>Quantity</th>
</tr>
</thead>
<tbody>
<tr>
<td>INA233EVM PCB Test Board</td>
<td>1</td>
</tr>
<tr>
<td>SM-USB-DIG Platform PCB</td>
<td>1</td>
</tr>
<tr>
<td>USB Extender Cable</td>
<td>1</td>
</tr>
</tbody>
</table>

Figure 1-1. Hardware Included With INA233EVM Kit
1.2 Related Documentation from Texas Instruments

The following documents provide information regarding Texas Instruments integrated circuits used in the assembly of the INA233EVM. This EVM user’s guide is available from the TI web site under literature number SBOU187. Any letter appended to the literature number corresponds to the document revision that is current at the time of the writing of this document. Newer revisions can be available from the TI web site. When ordering, identify the document by both title and literature number.

<table>
<thead>
<tr>
<th>DOCUMENT</th>
<th>LITERATURE NUMBER</th>
</tr>
</thead>
<tbody>
<tr>
<td>INA233 Product Data Sheet</td>
<td>SBOS790</td>
</tr>
<tr>
<td>SM-USB-DIG Platform User Guide</td>
<td>SBOU098</td>
</tr>
</tbody>
</table>

2 INA233EVM Hardware

Figure 2-1 shows the overall system setup for the INA233EVM. The PC runs software that communicates with the SM-USB-DIG Platform. The SM-USB-DIG Platform generates the analog and digital signals used to communicate with the INA233 test board. Connectors on the INA233EVM test board allow the user to connect to the system under test conditions and monitor the power, current, and voltage.

![Figure 2-1. INA233EVM Hardware Setup](image-url)
2.1 Theory of Operation for INA233 Hardware

Figure 2-2 depicts a block diagram of the INA233EVM PCB highlighting the power supplies, analog inputs, and digital I/O signals.

Figure 2-2. INA233EVM Board Block Diagram
2.2 Signal Definitions of H1 (10-Pin Connector Socket)

Table 2-1 lists the pinout for the 10-pin connector socket used to communicate between the INA233EVM and the SM-USB-DIG. It should be noted that the INA233EVM only uses the necessary $I^2C$ communication lines (pins 1 and 3) and the VS and GND pins (pin 6 and pin 8) to issue commands to the INA233 chip.

Table 2-1. Signal Definition of J4 on INA233EVM Board

<table>
<thead>
<tr>
<th>Pin on J4</th>
<th>Signal</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>I2C_SCL</td>
<td>$I^2C$ Clock Signal (SCL)</td>
</tr>
<tr>
<td>2</td>
<td>CTRL/MEAS4</td>
<td>GPIO: Control Output or Measure Input</td>
</tr>
<tr>
<td>3</td>
<td>I2C_SDA1</td>
<td>$I^2C$ Data Signal (SDA)</td>
</tr>
<tr>
<td>4</td>
<td>CTRL/MEAS5</td>
<td>GPIO: Control Output or Measure Input</td>
</tr>
<tr>
<td>5</td>
<td>SPI_DOUT1</td>
<td>SPI Data Output (PICO)</td>
</tr>
<tr>
<td>6</td>
<td>V_DUT</td>
<td>Switchable DUT Power Supply: +3.3 V, +5 V, Hi-Z (Disconnected) (1)</td>
</tr>
<tr>
<td>7</td>
<td>SPI_CLK</td>
<td>SPI Clock Signal (SCLK)</td>
</tr>
<tr>
<td>8</td>
<td>GND</td>
<td>Power Return (GND)</td>
</tr>
<tr>
<td>9</td>
<td>SPI_CS1</td>
<td>SPI Chip Select Signal (CS)</td>
</tr>
<tr>
<td>10</td>
<td>SPI_DIN1</td>
<td>SPI Data Input (POCI)</td>
</tr>
</tbody>
</table>

(1) When $V_{DUT}$ is Hi-Z, all digital I/O are Hi-Z as well.
2.2.1 SM-USB-DIG Platform Description

Figure 2-3 shows the block diagram for the SM-USB-DIG Platform. This platform is a general-purpose data acquisition system that is used on several different Texas Instruments evaluation modules. The details of its operation are included in a separate document, SBOU098 (available for download at www.ti.com). The block diagram shown in Figure 2-3 gives a brief overview of the platform. The primary control device on the SM-USB-DIG Platform is the TUSB3210. The TUSB3210 is an 8052 microcontroller that has an onboard USB interface. The microcontroller receives information from the host computer that it interprets into power, I²C, SPI, and other digital I/O patterns. During the digital I/O transaction, the microcontroller reads the response of any device connected to the I/O interface. The response from the device is sent back to the PC where it is interpreted by the host computer.

![Figure 2-3. SM-USB-DIG Platform Block Diagram](image-url)
3 INA233EVM Hardware Setup

Setting up the INA233EVM involves the following sequence of operations:

• Perform a one-time GUI software installation
• Configure the EVM jumpers
• Connect the hardware
• Power-up the EVM and input source

3.1 Electrostatic Discharge Warning

CAUTION

Many of the components on the INA233EVM are susceptible to damage by electrostatic discharge (ESD). Customers are advised to observe proper ESD handling precautions when unpacking and handling the EVM, including the use of a grounded wrist strap at an approved ESD workstation.

3.2 One-Time INA233EVM GUI Software Setup

This section discusses how to install the INA233EVM software.

3.2.1 Hardware Requirements

The INA233EVM software must be installed on a computer running Windows® XP operating system or later. Windows 7 is the recommended operating system.

3.2.2 Software Installation

Make sure the hardware is not connected to the computer. Download the INA233EVM GUI from the INA233 Tools & Software folder. Extract the contents of the downloaded .zip file and run Setup_INA233EVM.exe. Follow the on-screen instructions provided in Figure 3-1 to complete the software installation.

Figure 3-1. INA233EVM Software Installation
3.3 Configuration of INA233EVM Jumper Settings

Figure 3-2 shows the default jumper configuration for the INA233EVM. In general, the jumper settings of the SM-USB-DIG Platform do not need to be changed. Change the jumpers on the INA233EVM board to match your specific configuration. For example, set a specific I²C address by configuring J1 and J2.

![Figure 3-2. INA233EVM Default Jumper Settings](image)

Typically, jumper 3 (J3) on the INA233EVM is always set to the INT position. When set to the INT position, the SM-USB-DIG Platform provides the supply for the INA233. When this jumper is set to the EXT position, an external supply voltage can be connected to test point VS_EXT to provide the supply for the INA233.

Jumper 1 (J1) and jumper 2 (J2) control the I²C address pins for the INA233. These jumpers can set the address for A0 and A1 to either supply, ground, SCL, or SDA. Make sure to only connect one jumper at a time for each address control. Failure to properly connect jumpers can cause shorts or interruptions in the communication lines. For more information on the INA233 addressing, refer to the INA233 product data sheet.

Table 3-1 summarizes the function of the INA233 Test Board jumpers. For most applications, all jumpers must be left in the respective default configurations.

<table>
<thead>
<tr>
<th>Jumper</th>
<th>Default</th>
<th>Purpose</th>
</tr>
</thead>
<tbody>
<tr>
<td>J3</td>
<td>INT</td>
<td>This jumper selects whether the VS pin on the INA233 is connected to the V_DUT signal generated from the SM-USB-DIG Platform or whether the digital supply pin is connected to test point VS_EXT, allowing for an external supply to power the device. The default INT position connects the VS pin to the V_DUT control signal.</td>
</tr>
<tr>
<td>J1</td>
<td>GND</td>
<td>This jumper selects the I²C A0 address selection for A0.</td>
</tr>
<tr>
<td>J2</td>
<td>GND</td>
<td>This jumper selects the I²C A1 address selection for A1.</td>
</tr>
</tbody>
</table>
3.4 Connecting the Hardware

To set up the INA233EVM and connect the two PCBs of the EVM together (that is, the INA233 test board and SM-USB-DIG Platform board), gently slide the male and female ends of the 10-pin connectors together. Make sure that the two connectors are completely pushed together; loose connections can cause intermittent operation. Figure 3-3 show the proper orientation.

![Figure 3-3. Connecting the INA233 Test Board and SM-USB-DIG Platform Board to the Computer](image)

Lastly, connect the SM-USB-DIG to the computer, using the included USB extender cable. At this point the SM-USB-DIG powers on, but the EVM does not as shown in Figure 3-4. The power supply to the EVM must be enabled from the GUI.

![Figure 3-4. Connecting the INA233 Test Board and SM-USB-DIG Platform Board](image)
3.4.1 System Power Up

Launch the INA233EVM GUI software. By default the Power button on the GUI is enabled so the VS LED on the EVM (D1) immediately lights up, indicating that the EVM PCB is receiving power, as shown Figure 3-5.

![INA233 Power Up Using SM_USB DIG and INA233EVM GUI Software](image)

Figure 3-5. INA233 Power Up Using SM_USB DIG and INA233EVM GUI Software

The INA233EVM software allows users to customize the board level voltage, regulated by the SM-USB DIG. By selecting either 3.3 V or 5 V, the user can designate which voltage the device operates at. The supply voltage (VDUT) is set to 3.3 V by default, but if necessary, the 5-V option can be selected, as shown in Figure 3-6.

![VDUT Voltage Selection in INA233EVM GUI](image)

Figure 3-6. VDUT Voltage Selection in INA233EVM GUI
3.5 INA233EVM Features

This section describes some of the hardware features present on the INA233EVM test board.

3.5.1 J3: I²C VS Control Setting

Jumper J3 selects what the INA233 supply pin is connected to. If J3 is set to the INT position, the VS pin is connected to the switchable V_DUT signal generated from the SM-USB-DIG Platform. This voltage can be set to either 3.3 V or 5 V, depending on how it is configured in the software. While J2 is set in the INT position, the VS Power button in the INA233EVM software is able to control whether the V_DUT supply voltage is turned on or off. When J2 is set in the EXT position, an external supply connected to test point VS_EXT can be used to provide the supply voltage for the INA233.

3.5.2 J1: I²C Address Hardware Setting (A0)

Jumper J1 is used to set the hardware setting for the A0 I²C address pin on the INA233. Using J1, the A0 address can be set to VS, GND, SCL or SDA. See Section 4.2.1 on how to configure the INA233EVM software to match the J1 hardware setting.

3.5.3 J2: I²C Address Hardware Setting (A1)

Jumper J2 is used to set the hardware setting for the A1 I²C address pin on the INA233. Using J2, the A1 address can be set to VS, GND, SCL or SDA. See Section 4.2.1 on how to configure the INA233EVM software to match the J2 hardware setting.

3.5.4 External I²C Lines and Test Points SCL and SDA

The I²C communication lines on the INA233EVM are tied to two sources: the internal I²C communication lines from the SM-USB-DIG and test points SCL and SDA. If the user wants to add external signals separate from the SM-USB-DIG, simply disconnect the SM-USB-DIG from the INA233EVM board and hook up the necessary SDA, SCL, and GND lines. Also, remember to apply an external supply to the lines that is compatible with the I²C communication device being used.

Note

Failure to disconnect the SM-USB-DIG while using external I²C communication can cause damage to the SM-USB-DIG or any external communication devices that are connected.

3.5.5 IN+/IN– Input Filter (R1, R2, and C1)

The INA233EVM has an optional input filter to remove high-frequency noise from the inputs IN+ and IN–. This filter is typically unpopulated. The default values for R1 and R2 are 0-Ω resistors.
3.5.6 Shunt Monitor Configuration

The INA233 is generally used in either a high-side or low-side shunt configuration, as shown in Figure 3-7. Depending on the user’s needs, either of these configurations can be used without making any changes to the INA233EVM board or software. The INA233EVM have VBUS, GND, IN+ and IN- test points. Use these test points to apply external voltage sources depending the configuration selected.

![Figure 3-7. INA233 Shunt Configurations](image-url)
4 INA233EVM Software Overview

This section discusses how to use the INA233EVM software. Software operation involves a two-step process: configuration of the INA233 settings, and operation of the tool.

4.1 Starting the INA233EVM Software

The INA233 software can be operated through the Windows Start menu. From Start, select All Programs; then select the INA233EVM program.

Figure 4-1 illustrates how the software appears if the INA233EVM is functioning properly. The Status Bar reads "VDUT On" and the Hardware Connected bar is on.

![INA233EVM Software Interface]

Figure 4-1. INA233EVM Software Interface
Figure 4-2 shows how the Software Interface looks if the computer cannot communicate with the EVM. The status bar reads “Check SM-USB-DIG-Connection” and the Hardware Connected light is off. If you receive this error, first check to see that the USB cable is properly connected on both ends. This error can also occur if you connect the USB cable before the SM-USB-DIG Platform power source. Another possible source for this error is a problem with your PC USB Human Interface Device driver. Make sure that the device is recognized when the USB cable is plugged in; recognition is indicated by a Windows-generated confirmation sound. After verifying all connections are correct, press Re-Initialize. The software interface then appears as shown in Figure 4-1.

Figure 4-2. INA233EVM Software: Communication Error With the SM-USB-DIG Platform

4.2 Configuring the INA233EVM Software

The INA233EVM software first requires a series of setup processes to configure the device and make sure that the software works properly.
1. Set \( \text{i}^2\text{C} \) Address on the SM-USB-DIG Tab
2. Set Configuration Register on the Device Config Tab
   - Set Averaging Mode
   - Set Conversion Times
   - Set Operating Modes
3. Set Calibration Register on the Device Config Tab
4. Set the MFR\_DEVICE\_CONFIG Register on the Device Config Tab
5. Set the Warning Limits Registers on the Limit Config Tab
4.2.1 I2C Address Selection

The INA233 device has a flexible I2C address configuration that allows for multiple devices to be on the same I2C lines. By moving the A0 and A1 addresses on jumpers J1 and J2 to either GND, VS, SDA, or SCL, the INA233 can be changed to a total of 16 I2C addresses as shown in Table 4-1.

Table 4-1. INA233 I2C Address Configuration

<table>
<thead>
<tr>
<th>A1</th>
<th>A0</th>
<th>Slave Address</th>
<th>Corresponding I2C Address in the GUI</th>
</tr>
</thead>
<tbody>
<tr>
<td>GND</td>
<td>GND</td>
<td>1000000</td>
<td>Read: x81 Write: x80</td>
</tr>
<tr>
<td>GND</td>
<td>VS</td>
<td>1000001</td>
<td>Read: x83 Write: x82</td>
</tr>
<tr>
<td>GND</td>
<td>SDA</td>
<td>1000010</td>
<td>Read: x85 Write: x84</td>
</tr>
<tr>
<td>GND</td>
<td>SCL</td>
<td>1000011</td>
<td>Read: x87 Write: x86</td>
</tr>
<tr>
<td>VS</td>
<td>GND</td>
<td>1000100</td>
<td>Read: x89 Write: x88</td>
</tr>
<tr>
<td>VS</td>
<td>VS</td>
<td>1000101</td>
<td>Read: x8A Write: x8B</td>
</tr>
<tr>
<td>VS</td>
<td>SDA</td>
<td>1000110</td>
<td>Read: x8D Write: x8C</td>
</tr>
<tr>
<td>VS</td>
<td>SCL</td>
<td>1000111</td>
<td>Read: x8F Write: x8E</td>
</tr>
<tr>
<td>SDA</td>
<td>GND</td>
<td>1001000</td>
<td>Read: x91 Write: x90</td>
</tr>
<tr>
<td>SDA</td>
<td>VS</td>
<td>1001001</td>
<td>Read: x93 Write: x92</td>
</tr>
<tr>
<td>SDA</td>
<td>SDA</td>
<td>1001010</td>
<td>Read: x95 Write: x94</td>
</tr>
<tr>
<td>SDA</td>
<td>SCL</td>
<td>1001101</td>
<td>Read: x97 Write: x96</td>
</tr>
<tr>
<td>SCL</td>
<td>GND</td>
<td>1001100</td>
<td>Read: x99 Write: x98</td>
</tr>
<tr>
<td>SCL</td>
<td>VS</td>
<td>1001101</td>
<td>Read: x9B Write: x9A</td>
</tr>
<tr>
<td>SCL</td>
<td>SDA</td>
<td>1001110</td>
<td>Read: x9D Write: x9C</td>
</tr>
<tr>
<td>SCL</td>
<td>SCL</td>
<td>1001111</td>
<td>Read: x9F Write: x9E</td>
</tr>
</tbody>
</table>

Figure 4-3 illustrates how to configure the I2C addresses. To configure the I2C address in the GUI navigate to the SM-USB-DIG tab. Click on the Read I2C Address and Write I2C Address to input the I2C address configured on the INA233EVM hardware. Refer to Table 4-1 to make sure you assign the correct values.

Figure 4-3. Setting the I2C Address
4.2.2 Set the Configuration Register (MFR_ADC_CONFIG)

The Configuration Register settings control the operating modes for the device. This register controls the conversion time settings for both the shunt and bus voltage measurements as well as the averaging mode used. The operating mode that controls what signals are selected to be measured is also programmed in the Configuration Register. The Device Configuration tab of the INA233EVM GUI allows the user to set the averaging mode (AVG[2:0]), Vbus conversion time (VBUSCT[2:0]), Vshunt conversion time (VSHCT[2:0]) and operating mode (MODE[2:0]).

4.2.2.1 Set Averaging Mode

The Device Configuration tab contains a drop down box for selecting the Averaging Mode, as shown in Figure 4-4. The averaging mode selected determines the number of samples that are collected and averaged before storing the value of the measurements in the register table.

![Configuring Averaging Mode](image)

**Figure 4-4. Configuring Averaging Mode**

4.2.2.2 Set Conversion Times

Setting the conversion times allows the user to customize the amount of measurement time for conversions. Typically, for the INA233EVM software, the user is not able to notice a visual difference between the conversion times unless a high averaging mode and conversion time are chosen. The Shunt and Bus conversion times can be set as shown in Figure 4-5.

![Configuring Conversion Times](image)

**Figure 4-5. Configuring Conversion Times**
4.2.2.3 Set Operating Mode

The Device Configuration tab contains a drop down box for selecting the Operating Mode, as shown in Figure 4-6. The Operating mode allows the user to restrict the amount of calculations done within the INA233 by changing the conversion to be triggered or continuous, or shutting down the part altogether. The Device Configuration tab of the INA233EVM GUI allows the user to set the averaging mode (AVG[2:0]), Vbus conversion time (VBUSCT[2:0]), Vshunt conversion time (VSHCT[2:0]) and operating mode (MODE[2:0]).

It is important to note that for complete functionality of the INA233, a configuration must be chosen with Shunt and Bus configuration. Failure to choose Shunt and Bus configuration disables a considerable portion of the unit functionality as discussed in the INA233 data sheet.

![Figure 4-6. Configuring Operating Mode](image)

4.2.3 Set Calibration Register (MFR_CALIBRATION)

The Calibration Register must then be set correctly for the software to operate properly. The user needs to manually calculate the desired value using Equation 1 and then input that value into the MFR_Calibration box, as shown in Figure 4-7. After this, the user must press W in order to write into the Calibration Register. If inputs were correct the MFR_CALIBRATION and MFR_CALIBRATION Hex boxes should display the same values after pressing R (Pressing R reads the Calibration Register).

$$\text{Calibration Register} = \frac{0.00512}{\text{Current_LSB} \times R_{\text{SHUNT}}}$$  \hspace{1cm} (1)

The current LSB is calculated by a recommended range in the INA233 data sheet as shown in Equation 2. It is important to note that the Current LSB and the Calibration Register values are calculated based on the other variable and the $R_{\text{SHUNT}}$ value. See the section, Programming the INA233 in the product data sheet for more information on setting the Calibration Register value.

$$\frac{2^{15}}{2^{12}} \leq \text{Current_LSB} \leq \frac{2^{15}}{2^{12}}$$  \hspace{1cm} (2)

![Figure 4-7. Setting the Calibration Register (MFR_CALIBRATION)](image)
4.2.4 Set the MFR_DEVICE_CONFIG Register

This register configures various behaviors of the device in regards to data communications and alerts. The user is able to write and read these registers in the Device Configuration Tab as shown in Figure 4-8. Refer to MFR_DEVICE_CONFIG Register section on the data sheet for register details.

![Figure 4-8. Set the MFR_DEVICE_CONFIG Register](image)

4.2.5 Set the MFR_ALERT_MASK

The bits in this register correspond to the bits in the STATUS_MFR_SPECIFIC register. Setting a bit in this register will block the corresponding bit in the STATUS_MFR_SPECIFIC register from having an effect on the ALERT pin. The user is able to write and read these registers in the Device Configuration Tab as shown in Figure 4-9. Refer to MFR_ALERT_MASK Register table in the data sheet for register bits details.

![Figure 4-9. Set the MFR_ALERT_MASK Register](image)

4.2.6 Set the Warning Limit Registers

The Limit configuration tab allows the user to set the values for the following warning limit registers:

- OUT_OC_WARN_LIMIT Register
- VIN_OV_WARN_LIMIT Register
- VIN_UV_WARN_LIMIT Register
- POUT_OP_WARN_LIMIT Register

The user is able to write and read these registers in the Device Configuration Tab as shown in Figure 4-10. Refer to data sheet Standard PMBus Commands section for register descriptions.

![Figure 4-10. Set the Warning Limit Registers](image)
4.3 Using the INA233EVM Software

After configuring the INA233EVM software, the rest of the tabs can be evaluated. This section describes the basic operation of the device, and offers guidelines for interpreting the graphic user interface (GUI).

4.3.1 Read Data Tab

Navigate to the Read Data tab, refer to Figure 4-11. This Tab allows the user to read the following registers:

- **READ_EIN (0x86h)**: Retrieves the energy reading measurement.
- **READ_VIN (0x88h)**: Retrieves input BUS voltage measurement.
- **READ_IIN (0x89h)**: Retrieves the input current measurement.
- **READ_PIN (0x97h)**: Retrieves the input power measurement.
- **READ_VSHUNT_OUT (0xD1h)**: Retrieves shunt voltage measurement.

![Read Data Tab](image)

Figure 4-11. Read Data Tab
4.3.2 Status Register Tab

Navigate to the Status Registers Tab, refer to Figure 4-12. This Tab allows the user to read the following registers:

- **STATUS BYTE (0x78h)**: Retrieves information about the part's operating status.
- **STATUS_WORD (0x79h)**: Retrieves information about the part's operating status.
- **STATUS_IOUT (0x7Bh)**: Retrieves information about output current status.
- **STATUS_INPUT (0x7Ch)**: Retrieves information about input status.
- **STATUS_CML (0x7Eh)**: Retrieves information about communications status.
- **STATUS_MFR_SPECIFIC (0x80h)**: Retrieves information about manufacturer-specific device status.

![Figure 4-12. Status Register Tab](image)
4.3.3 Register Map Tab

The Register tab contains information on the individual operation of the INA233 registers as shown in Figure 4-13.

![Register Map Tab](image-url)

**Figure 4-13. Registers Map Tab**
4.3.4 Plots Tab

The Plots tab contains a plot window that shows the progression of data over time on the INA233. All four variables at the bottom of the EVM software (Vshunt (READ_VSHUNT_OUT), Vbus (READ_VIN), Current (READ_IIN) and Power (READ_PIN)) can be plotted using the drop-down box directly below the graph. After the desired plot has been selected, toggle the Capture Data in Loop button above the plot to begin polling for data.

Figure 4-14. Graphing the INA233 Data
5 INA233EVM Documentation

This section contains the complete bill of materials, schematic diagram, and PCB layout for the INA233EVM.

**Note**

The board layout is not to scale. This image is intended to show how the board is laid out; it is not intended to be used for manufacturing INA233EVM PCBs.

5.1 Schematic

*Figure 5-1* shows the schematic for the INA233EVM.

![INA233EVM Schematic](image-url)

*Figure 5-1. INA233EVM Schematic*
5.2 PCB Layout

Figure 5-2 through Figure 5-5 illustrate the PCB layout for the INA233EVM.

Figure 5-2. INA233EVM PCB Top Overlay

Figure 5-3. INA233EVM PCB Top Solder
Figure 5-4. INA233EVM PCB Top Layer

Figure 5-5. INA233EVM PCB Bottom Layer
### 5.3 Bill of Materials

Table 5-1 lists the bill of materials for the INA233EVM.

<table>
<thead>
<tr>
<th>DESIGNATOR</th>
<th>QUANTITY</th>
<th>VALUE</th>
<th>DESCRIPTION</th>
<th>PACKAGE REFERENCE</th>
<th>PART NUMBER</th>
<th>MANUFACTURER</th>
</tr>
</thead>
<tbody>
<tr>
<td>IPCB</td>
<td>1</td>
<td></td>
<td>Printed Circuit Board</td>
<td></td>
<td>MHR057</td>
<td>Any</td>
</tr>
<tr>
<td>C2, C3</td>
<td>2</td>
<td>0.1 µF</td>
<td>CAP, CERM, 0.1 µF, 50 V, ±5%, X7R, 0805</td>
<td>0805</td>
<td>08055C104JAT2A</td>
<td>AVX</td>
</tr>
<tr>
<td>D1</td>
<td>1</td>
<td>Green</td>
<td>LED, Green, SMD</td>
<td>LED_0805</td>
<td>APT2012LZGCK</td>
<td>Kingbright</td>
</tr>
<tr>
<td>D2</td>
<td>1</td>
<td>Red</td>
<td>LED, Red, SMD</td>
<td>SMD, 2-Leads, Body 2×1.25mm</td>
<td>APT2012LSECK/J3-PRV</td>
<td>Kingbright</td>
</tr>
<tr>
<td>H9, H10, H11, H12</td>
<td>4</td>
<td></td>
<td>Bumpon, Hemisphere, 0.44×0.20, Clear</td>
<td>Transparent Bumpon</td>
<td>SJ-5303 (CLEAR)</td>
<td>3M</td>
</tr>
<tr>
<td>J1, J2</td>
<td>2</td>
<td></td>
<td>Header, 2.54mm, 4×2, Gold, SMT</td>
<td>Header, 2.54mm, 4×2, SMT</td>
<td>95278-801A08LF</td>
<td>FCI</td>
</tr>
<tr>
<td>J3</td>
<td>1</td>
<td></td>
<td>Header, 100mil, 3×1, Gold, SMT</td>
<td>Samtec_TSM-103-01-X-SV</td>
<td>TSM-103-01-L-SV</td>
<td>Samtec</td>
</tr>
<tr>
<td>J4</td>
<td>1</td>
<td></td>
<td>Receptacle, 50mil, 10×1, Gold, R/A, TH</td>
<td>receptacle 10×1, 50mil</td>
<td>851-43-010-20-001000</td>
<td>Mill-Max</td>
</tr>
<tr>
<td>Q1</td>
<td>1</td>
<td>–50 V</td>
<td>MOSFET, P-CH, –50 V, –0.13 A, SOT-23</td>
<td>SOT-23</td>
<td>BSS84-7-F</td>
<td>Diodes Inc.</td>
</tr>
<tr>
<td>R1, R2</td>
<td>2</td>
<td>0</td>
<td>RES, 0, 5%, 0.125 W, 0805</td>
<td>0805</td>
<td>CRCW08050000Z0EA</td>
<td>Vishay-Dale</td>
</tr>
<tr>
<td>R3, R4, R5, R6, R9</td>
<td>5</td>
<td>10.0 k</td>
<td>RES, 10.0 k, 1%, 0.125 W, 0805</td>
<td>0805</td>
<td>CRCW080510K0FKEA</td>
<td>Vishay-Dale</td>
</tr>
<tr>
<td>R7, R8</td>
<td>2</td>
<td>49.9</td>
<td>RES, 49.9, 1%, 0.125 W, 0805</td>
<td>0805</td>
<td>CRCW080549R9FKEA</td>
<td>Vishay-Dale</td>
</tr>
<tr>
<td>SH-J1, SH-J2, SH-J3</td>
<td>3</td>
<td>1×2</td>
<td>Shunt, 100mil, Flash Gold, Black</td>
<td>Closed Top 100mil Shunt</td>
<td>SPC02SYAN</td>
<td>Sullins Connector Solutions</td>
</tr>
<tr>
<td>TP1, TP2, TP3, TP4, TP5, TP6, TP7, TP8, TP9, TP10</td>
<td>10</td>
<td></td>
<td>Test Point, Compact, SMT</td>
<td>Testpoint_Keystone_Comp act</td>
<td>5016</td>
<td>Keystone</td>
</tr>
<tr>
<td>U1</td>
<td>1</td>
<td></td>
<td>High-Side or Low-Side Measurement, Bidirectional Current and Power Monitor with PMBus Compatible Interface, DGS0010A (10-pin VSSOP)</td>
<td>DGS0010A</td>
<td>INA233AIDGSR</td>
<td>Texas Instruments</td>
</tr>
</tbody>
</table>

---

**Table 5-1. Bill of Materials: INA233EVM**

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## 6 Revision History

Changes from Revision * (April 2017) to Revision A (April 2023)          Page

- Changed the numbering format for tables, figures, and cross-references throughout the document.............. 1
- Changed document title to include software tutorial content................................................................. 1
- Added registered trademark for Windows®............................................................... 9
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CAUTION
This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation. Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

FCC Interference Statement for Class A EVM devices
NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

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- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210 or RSS-247

Concerning EVMs Including Radio Transmitters:
This device complies with Industry Canada license-exempt RSSs. Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concernant les EVMs avec appareils radio:
Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

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Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.
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Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance reçue pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur.

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If User uses EVMs in Japan, not certified to Technical Regulations of Radio Law of Japan, User is required to follow the instructions set forth by Radio Law of Japan, which includes, but is not limited to, the instructions below with respect to EVMs (which for the avoidance of doubt are stated strictly for convenience and should be verified by User):

1. Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on sub-section 1.1 of Article 6 of the Ministry’s Rule for Enforcement of Radio Law of Japan.

2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or

3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.

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EVM Use Restrictions and Warnings:

4.1 EVMS ARE NOT FOR USE IN FUNCTIONAL SAFETY AND/OR SAFETY CRITICAL EVALUATIONS, INCLUDING BUT NOT LIMITED TO EVALUATIONS OF LIFE SUPPORT APPLICATIONS.

4.2 User must read and apply the user guide and other available documentation provided by TI regarding the EVM prior to handling or using the EVM, including without limitation any warning or restriction notices. The notices contain important safety information related to, for example, temperatures and voltages.

4.3 Safety-Related Warnings and Restrictions:

4.3.1 User shall operate the EVM within TI's recommended specifications and environmental considerations stated in the user guide, other available documentation provided by TI, and any other applicable requirements and employ reasonable and customary safeguards. Exceeding the specified performance ratings and specifications (including but not limited to input and output voltage, current, power, and environmental ranges) for the EVM may cause personal injury or death, or property damage. If there are questions concerning performance ratings and specifications, User should contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may also result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM user guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, even with the inputs and outputs kept within the specified allowable ranges, some circuit components may have elevated case temperatures. These components include but are not limited to linear regulators, switching transistors, pass transistors, current sense resistors, and heat sinks, which can be identified using the information in the associated documentation. When working with the EVM, please be aware that the EVM may become very warm.

4.3.2 EVMs are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems. User assumes all responsibility and liability for proper and safe handling and use of the EVM by User or its employees, affiliates, contractors or designees. User assumes all responsibility and liability to ensure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard. User assumes all responsibility and liability for any improper or unsafe handling or use of the EVM by User or its employees, affiliates, contractors or designees.

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8.2 Specific Limitations. IN NO EVENT SHALL TI'S AGGREGATE LIABILITY FROM ANY USE OF AN EVM PROVIDED HEREUNDER, INCLUDING FROM ANY WARRANTY, INDEMNITY OR OTHER OBLIGATION ARISING OUT OF OR IN CONNECTION WITH THESE TERMS, EXCEED THE TOTAL AMOUNT PAID TO TI BY USER FOR THE PARTICULAR EVM(S) AT ISSUE DURING THE PRIOR TWELVE (12) MONTHS WITH RESPECT TO WHICH LOSSES OR DAMAGES ARE CLAIMED. THE EXISTENCE OF MORE THAN ONE CLAIM SHALL NOT ENLARGE OR EXTEND THIS LIMIT.

9. Return Policy. Except as otherwise provided, TI does not offer any refunds, returns, or exchanges. Furthermore, no return of EVM(s) will be accepted if the package has been opened and no return of the EVM(s) will be accepted if they are damaged or otherwise not in a resalable condition. If User feels it has been incorrectly charged for the EVM(s) it ordered or that delivery violates the applicable order, User should contact TI. All refunds will be made in full within thirty (30) working days from the return of the components(s), excluding any postage or packaging costs.

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